

# **High-Density Interconnect (HDI) PCB Market by End User (Consumer Electronics, Automotive, Industrial Electronics, IT & Telecommunications, and Others) and Application (Smartphone & Tablet, Laptop & PC, Smart Wearables, and Others): Global Opportunity Analysis and Industry Forecast, 2018 - 2025**

<https://marketpublishers.com/r/H801795DA08EN.html>

Date: November 2018

Pages: 238

Price: US\$ 4,296.00 (Single User License)

ID: H801795DA08EN

## **Abstracts**

### **HDI PCB Market Overview:**

The global HDI PCB market was valued at \$9,491.0 million in 2017 and is projected to reach \$22,258.8 million by 2025, registering a CAGR of 11.1% from 2018 to 2025.

A high-density interconnect (HDI) is a fastest growing technology used in the printed circuit board (PCB), which have higher wiring density per unit as compared to the conventional circuit boards. These HDI PCBs have finer lines and spaces (? 100 µm), smaller vias (? 150 µm), and capture pads (? 400 µm). Moreover, HDI PCBs have a relatively higher connection pad density over conventional PCBs that is over 20 pads/cm<sup>2</sup>. Hence, they are widely adopted in the consumer electronics sector and have a high growth potential in the automotive industry.

The companies operating in the market have adopted strategies such as collaboration, partnership, product launch, R&D, and acquisition to increase their market share and expand their geographical presence. The global HDI PCB market is analyzed and estimated in accordance with the impact of the drivers, restraints, and opportunities. The period studied in this report is 2017–2025, wherein the forecast period is 2018–2025.

The report includes the study of the global HDI PCB market with respect to the growth prospects and restraints based on the regional analysis. The study includes Porter's five forces analysis of the industry to determine the impact of suppliers, competitors, new entrants, substitutes, and buyers on the market growth.

The market is segmented based on end user and application. Based on end user, the market is divided into consumer electronics, automotive, industrial electronics, IT & telecommunications, and others. Based on application, the market is categorized into smartphone & tablet, laptop & PC, smart wearables, and others. By region, the market is analyzed across North America, Europe, Asia-Pacific, and LAMEA.

The key players profiled in the report include Compeq Manufacturing Co. Ltd., TTM Technologies, Unimicron, AT&S, Ibiden Group, SEMCO, Unitech Printed Circuit Board Corp., Tripod Technology Corp., DAP Corporation and Meiko.

#### Key Benefits for HDI PCB Market:

This study presents an analytical depiction of the global HDI PCB market along with the current trends and future estimations to depict the imminent investment pockets.

The overall market potential is determined to understand the profitable trends to gain a strong foothold in the market.

The report presents information related to key drivers, restraints, and opportunities with a detailed impact analysis.

The current market is quantitatively analyzed from 2017 to 2025 to highlight the financial competency of the market.

Porter's five forces analysis illustrates the potency of the buyers and suppliers.

#### HDI PCB Key Market Segments:

##### By End User

##### Consumer Electronics

Automotive

Industrial Electronics

IT & Telecommunications

Others

### By Application

Smartphone & Tablet

Laptop & PC

Smart Wearables

Others

### By Region

North America

U.S.

Canada

Mexico

Europe

UK

Germany

France

Russia

Rest of Europe

Asia-Pacific

China

Japan

India

South Korea

Rest of Asia-Pacific

LAMEA

Latin America

Middle East

Africa

## Key Market Players Profiled

Siemens AG

Compeq Manufacturing Co. Ltd.

TTM Technologies, Inc.

Unimicron

AT&S

Ibiden Group

SEMCO

Unitech Printed Circuit Board Corp.

Tripod Technology Corp.

DAP Corporation

Meiko Electronics Co. Ltd.

## Contents

### **CHAPTER 1: INTRODUCTION**

- 1.1. REPORT DESCRIPTION
- 1.2. KEY BENEFITS FOR STAKEHOLDERS
- 1.3. KEY MARKET SEGMENTS
- 1.4. RESEARCH METHODOLOGY
  - 1.4.1. Primary research
  - 1.4.2. Secondary research
  - 1.4.3. Analyst tools and models

### **CHAPTER 2: EXECUTIVE SUMMARY**

- 2.1. CXO PERSPECTIVE

### **CHAPTER 3: MARKET OVERVIEW**

- 3.1. MARKET DEFINITION AND SCOPE
- 3.2. KEY FINDINGS
  - 3.2.1. Top impacting factors
  - 3.2.2. Top investment pockets
  - 3.2.3. Top winning strategies
- 3.3. PORTERS FIVE FORCES ANALYSIS
- 3.4. MARKET SHARE ANALYSIS (2017)
- 3.5. MARKET DYNAMICS
  - 3.5.1. Drivers
    - 3.5.1.1. Miniaturization of size and lower weight
    - 3.5.1.2. High efficiency
    - 3.5.1.3. Growing sales of consumer electronics
  - 3.5.2. Restraint
    - 3.5.2.1. High Construction Cost
  - 3.5.3. Opportunities
    - 3.5.3.1. Increase in utilization of HDI technology in automobiles

### **CHAPTER 4: HDI PCB MARKET, BY END-USER**

- 4.1. OVERVIEW
- 4.2. CONSUMER ELECTRONICS

- 4.2.1. Key market trends, growth factors and opportunities
- 4.2.2. Market size and forecast, by region
- 4.2.3. Market analysis by country

#### 4.3. AUTOMOTIVE

- 4.3.1. Key market trends, growth factors, and opportunities
- 4.3.2. Market size and forecast, by region
- 4.3.3. Market analysis by country

#### 4.4. INDUSTRIAL ELECTRONICS

- 4.4.1. Key market trends, growth factors, and opportunities
- 4.4.2. Market size and forecast, by region
- 4.4.3. Market analysis by country

#### 4.5. IT & TELECOMMUNICATIONS

- 4.5.1. Key market trends, growth factors, and opportunities
- 4.5.2. Market size and forecast, by region
- 4.5.3. Market analysis by country

#### 4.6. OTHERS

- 4.6.1. Key market trends, growth factors, and opportunities
- 4.6.2. Market size and forecast, by region
- 4.6.3. Market analysis by country

### **CHAPTER 5: HDI PCB MARKET, BY APPLICATION**

#### 5.1. OVERVIEW

#### 5.2. SMARTPHONE & TABLET

- 5.2.1. Key market trends, growth factors and opportunities
- 5.2.2. Market size and forecast, by region
- 5.2.3. Market analysis by country

#### 5.3. PC & LAPTOP

- 5.3.1. Key market trends, growth factors, and opportunities
- 5.3.2. Market size and forecast, by region
- 5.3.3. Market analysis by country

#### 5.4. SMART WEARABLE

- 5.4.1. Key market trends, growth factors, and opportunities
- 5.4.2. Market size and forecast, by region
- 5.4.3. Market analysis by country

#### 5.5. OTHERS

- 5.5.1. Key market trends, growth factors, and opportunities
- 5.5.2. Market size and forecast, by region
- 5.5.3. Market analysis by country

## **CHAPTER 6: HDI PCB MARKET, BY REGION**

### **6.1. OVERVIEW**

### **6.2. NORTH AMERICA**

6.2.1. Key market trends, growth factors, and opportunities

6.2.2. Market size and forecast, by End-User

6.2.3. Market size and forecast, by application

6.2.4. Market analysis by country

6.2.4.1. U.S.

6.2.4.1.1. Market size and forecast, by End-User

6.2.4.1.2. Market size and forecast, by application

6.2.4.2. Canada

6.2.4.2.1. Market size and forecast, by End-User

6.2.4.2.2. Market size and forecast, by application

6.2.4.3. Mexico

6.2.4.3.1. Market size and forecast, by End-User

6.2.4.3.2. Market size and forecast, by application

### **6.3. EUROPE**

6.3.1. Key market trends, growth factors, and opportunities

6.3.2. Market size and forecast, by End-User

6.3.3. Market size and forecast, by application

6.3.4. Market analysis by country

6.3.4.1. U.K.

6.3.4.1.1. Market size and forecast, by End-User

6.3.4.1.2. Market size and forecast, by application

6.3.4.2. Germany

6.3.4.2.1. Market size and forecast, by End-User

6.3.4.2.2. Market size and forecast, by application

6.3.4.3. France

6.3.4.3.1. Market size and forecast, by End-User

6.3.4.3.2. Market size and forecast, by application

6.3.4.4. Russia

6.3.4.4.1. Market size and forecast, by End-User

6.3.4.4.2. Market size and forecast, by application

6.3.4.5. Rest of Europe

6.3.4.5.1. Market size and forecast, by End-User

6.3.4.5.2. Market size and forecast, by application

### **6.4. ASIA-PACIFIC**



6.4.1. Key market trends, growth factors, and opportunities

6.4.2. Market size and forecast, by End-User

6.4.3. Market size and forecast, by application

6.4.4. Market analysis by country

6.4.4.1. China

6.4.4.1.1. Market size and forecast, by End-User

6.4.4.1.2. Market size and forecast, by application

6.4.4.2. Japan

6.4.4.2.1. Market size and forecast, by End-User

6.4.4.2.2. Market size and forecast, by application

6.4.4.3. India

6.4.4.3.1. Market size and forecast, by End-User

6.4.4.3.2. Market size and forecast, by application

6.4.4.4. South Korea

6.4.4.4.1. Market size and forecast, by End-User

6.4.4.4.2. Market size and forecast, by application

6.4.4.5. Rest of Asia-Pacific

6.4.4.5.1. Market size and forecast, by End-User

6.4.4.5.2. Market size and forecast, by application

6.5. LAMEA

6.5.1. Key market trends, growth factors, and opportunities

6.5.2. Market size and forecast, by End-User

6.5.3. Market size and forecast, by application

6.5.4. Market analysis by country

6.5.4.1. Latin America

6.5.4.1.1. Market size and forecast, by End-User

6.5.4.1.2. Market size and forecast, by application

6.5.4.2. Middle East

6.5.4.2.1. Market size and forecast, by End-User

6.5.4.2.2. Market size and forecast, by application

6.5.4.3. Africa

6.5.4.3.1. Market size and forecast, by End-User

6.5.4.3.2. Market size and forecast, by application

## **CHAPTER 7: COMPANY PROFILES**

7.1. AT&S

7.1.1. Company overview

7.1.2. Company snapshot

- 7.1.3. Operating business segments
- 7.1.4. Product portfolio
- 7.1.5. Business performance
- 7.1.6. Key strategic moves and developments
- 7.2. COMPEQ
  - 7.2.1. Company overview
  - 7.2.2. Company snapshot
  - 7.2.3. Product portfolio
  - 7.2.4. Business performance
  - 7.2.5. Key strategic moves and developments
- 7.3. DAP CORPORATION
  - 7.3.1. Company overview
  - 7.3.2. Company snapshot
  - 7.3.3. Product portfolio
  - 7.3.4. Business performance
- 7.4. IBIDEN CO., LTD.
  - 7.4.1. Company overview
  - 7.4.2. Company snapshot
  - 7.4.3. Operating business segments
  - 7.4.4. Business performance
- 7.5. MEIKO ELECTRONICS CO., LTD.
  - 7.5.1. Company overview
  - 7.5.2. Company snapshot
  - 7.5.3. Product portfolio
  - 7.5.4. Business performance
  - 7.5.5. Key strategic moves and developments
- 7.6. SEMCO
  - 7.6.1. Company overview
  - 7.6.2. Company snapshot
  - 7.6.3. Operating business segments
  - 7.6.4. Product portfolio
  - 7.6.5. Business performance
- 7.7. TTM TECHNOLOGIES
  - 7.7.1. Company overview
  - 7.7.2. Company snapshot
  - 7.7.3. Operating business segments
  - 7.7.4. Product portfolio
  - 7.7.5. Business performance
  - 7.7.6. Key strategic moves and developments

## 7.8. TRIPOD TECHNOLOGY

- 7.8.1. Company overview
- 7.8.2. Company snapshot
- 7.8.3. Product portfolio
- 7.8.4. Business performance

## 7.9. UNIMICRON

- 7.9.1. Company overview
- 7.9.2. Company snapshot
- 7.9.3. Operating business segments
- 7.9.4. Product portfolio
- 7.9.5. Business performance
- 7.9.6. Key strategic moves and developments

## 7.10. UNITECH PCB

- 7.10.1. Company overview
- 7.10.2. Company snapshot
- 7.10.3. Product portfolio
- 7.10.4. Business performance

## List Of Tables

### LIST OF TABLES

TABLE 01. GLOBAL HDI PCB MARKET, BY END-USER, 2017-2025(\$MILLION)
TABLE 02. HDI PCB MARKET REVENUE FOR CONSUMER ELECTRONICS, BY REGION 2017-2025 (\$MILLION)
TABLE 03. HDI PCB MARKET REVENUE FOR AUTOMOTIVE, BY REGION 2017-2025 (\$MILLION)
TABLE 04. HDI PCB MARKET REVENUE FOR INDUSTRIAL ELECTRONICS, BY REGION 2017-2025 (\$MILLION)
TABLE 05. HDI PCB MARKET REVENUE FOR IT & TELECOMMUNICATIONS, BY REGION 2017-2025 (\$MILLION)
TABLE 06. HDI PCB MARKET REVENUE FOR OTHERS, BY REGION 2017-2025 (\$MILLION)
TABLE 07. GLOBAL HDI PCB MARKET, BY APPLICATION, 2017-2025(\$MILLION)
TABLE 08. HDI PCB MARKET REVENUE FOR SMARTPHONE & TABLET, BY REGION 2017-2025 (\$MILLION)
TABLE 09. HDI PCB MARKET REVENUE FOR PC & LAPTOP, BY REGION 2017-2025 (\$MILLION)
TABLE 10. HDI PCB MARKET REVENUE FOR SMART WEARABLE, BY REGION 2017-2025 (\$MILLION)
TABLE 11. HDI PCB MARKET REVENUE FOR OTHERS, BY REGION 2017-2025 (\$MILLION)
TABLE 12. NORTH AMERICA HDI PCB MARKET, BY END-USER, 2017-2025 (\$MILLION)
TABLE 13. NORTH AMERICA HDI PCB MARKET, BY APPLICATION, 2017-2025 (\$MILLION)
TABLE 14. U.S. HDI PCB MARKET, BY END-USER, 2017-2025 (\$MILLION)
TABLE 15. U.S. HDI PCB MARKET, BY APPLICATION, 2017-2025 (\$MILLION)
TABLE 16. CANADA HDI PCB MARKET, BY END-USER, 2017-2025 (\$MILLION)
TABLE 17. CANADA HDI PCB MARKET, BY APPLICATION, 2017-2025 (\$MILLION)
TABLE 18. MEXICO HDI PCB MARKET, BY END-USER, 2017-2025 (\$MILLION)
TABLE 19. MEXICO HDI PCB MARKET, BY APPLICATION, 2017-2025 (\$MILLION)
TABLE 20. EUROPE HDI PCB MARKET, BY END-USER, 2017-2025 (\$MILLION)
TABLE 21. EUROPE HDI PCB MARKET, BY APPLICATION, 2017-2025 (\$MILLION)
TABLE 22. U.K. HDI PCB MARKET, BY END-USER, 2017-2025 (\$MILLION)
TABLE 23. U.K. HDI PCB MARKET, BY APPLICATION, 2017-2025 (\$MILLION)
TABLE 24. GERMANY HDI PCB MARKET, BY END-USER, 2017-2025 (\$MILLION)

TABLE 25. GERMANY HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 26. FRANCE HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 27. FRANCE HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 28. RUSSIA HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 29. RUSSIA HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 30. REST OF EUROPE HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 31. REST OF EUROPE HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 32. ASIA-PACIFIC HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 33. ASIA-PACIFIC HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 34. CHINA HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 35. CHINA HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 36. JAPAN HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 37. JAPAN HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 38. INDIA HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 39. INDIA HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 40. SOUTH KOREA HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 41. SOUTH KOREA HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 42. REST OF ASIA-PACIFIC HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 43. REST OF ASIA-PACIFIC HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 44. LAMEA HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 45. LAMEA HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 46. LATIN AMERICA HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 47. LATIN AMERICA HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 48. MIDDLE EAST HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 49. MIDDLE EAST HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 50. AFRICA HDI PCB MARKET, BY END-USER, 20172025 (\$MILLION)
TABLE 51. AFRICA HDI PCB MARKET, BY APPLICATION, 20172025 (\$MILLION)
TABLE 52. AT&S: COMPANY SNAPSHOT
TABLE 53. AT&S: OPERATING SEGMENTS

TABLE 54. AT&S: PRODUCT PORTFOLIO
TABLE 55. AT&S: KEY STRATEGIC MOVES AND DEVELOPMENTS
TABLE 56. COMPEQ: COMPANY SNAPSHOT
TABLE 57. COMPEQ: PRODUCT PORTFOLIO
TABLE 58. COMPEQ: KEY STRATEGIC MOVES AND DEVELOPMENTS
TABLE 59. DAP CORPORATION: COMPANY SNAPSHOT
TABLE 60. DAP CORPORATION: PRODUCT PORTFOLIO
TABLE 61. IBIDEN CO.,LTD.: COMPANY SNAPSHOT
TABLE 62. IBIDEN CO.,LTD.: OPERATING SEGMENTS
TABLE 63. MEIKO ELECTRONICS CO., LTD.: COMPANY SNAPSHOT
TABLE 64. MEIKO ELECTRONICS CO., LTD.: PRODUCT PORTFOLIO
TABLE 65. MEIKO ELECTRONICS CO., LTD.: KEY STRATEGIC MOVES AND DEVELOPMENTS
TABLE 66. SEMCO: COMPANY SNAPSHOT
TABLE 67. SEMCO: OPERATING SEGMENTS
TABLE 68. SEMCO: PRODUCT PORTFOLIO
TABLE 69. TTM TECHNOLOGIES: COMPANY SNAPSHOT
TABLE 70. TTM TECHNOLOGIES: OPERATING SEGMENTS
TABLE 71. TTM TECHNOLOGIES: PRODUCT PORTFOLIO
TABLE 72. TTM TECHNOLOGIES: KEY STRATEGIC MOVES AND DEVELOPMENTS
TABLE 73. TRIPOD TECHNOLOGY: COMPANY SNAPSHOT
TABLE 74. TRIPOD TECHNOLOGY: PRODUCT PORTFOLIO
TABLE 75. UNIMICRON: COMPANY SNAPSHOT
TABLE 76. UNIMICRON: OPERATING SEGMENTS
TABLE 77. UNIMICRON: PRODUCT PORTFOLIO
TABLE 78. UNIMICRON: KEY STRATEGIC MOVES AND DEVELOPMENTS
TABLE 79. UNITECH PCB: COMPANY SNAPSHOT
TABLE 80. UNITECH PCB: PRODUCT PORTFOLIO

## List Of Figures

### LIST OF FIGURES

- FIGURE 01. KEY MARKET SEGMENTS
- FIGURE 02. EXECUTIVE SUMMARY
- FIGURE 03. EXECUTIVE SUMMARY
- FIGURE 04. TOP IMPACTING FACTORS
- FIGURE 05. TOP INVESTMENT POCKETS
- FIGURE 06. TOP WINNING STRATEGIES, BY YEAR, 2015-2018
- FIGURE 07. TOP WINNING STRATEGIES, BY YEAR, 2015-2018
- FIGURE 08. TOP WINNING STRATEGIES, BY COMPANY, 2015-2018
- FIGURE 09. MODERATE BARGAINING POWER OF SUPPLIERS
- FIGURE 10. LOW-TO-MODERATE THREAT OF NEW ENTRANTS
- FIGURE 11. MODERATE THREAT OF SUBSTITUTES
- FIGURE 12. HIGH-TO-MODERATE INTENSITY OF RIVALRY
- FIGURE 13. MODERATE BARGAINING POWER OF BUYERS
- FIGURE 14. MARKET SHARE ANALYSIS (2017)
- FIGURE 15. GLOBAL HDI PCB MARKET SHARE, BY END-USER, 2017-2025 (%)
- FIGURE 16. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR CONSUMER ELECTRONICS, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 17. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR AUTOMOTIVE, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 18. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR INDUSTRIAL ELECTRONICS, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 19. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR IT & TELECOMMUNICATIONS, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 20. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR OTHERS, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 21. GLOBAL HDI PCB MARKET SHARE, BY APPLICATION, 2017-2025 (%)
- FIGURE 22. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR SMARTPHONE & TABLET, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 23. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR PC & LAPTOP, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 24. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR OTHERS, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 25. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET FOR OTHERS, BY COUNTRY, 2017 & 2025 (%)
- FIGURE 26. HDI PCB MARKET, BY REGION, 2017-2025 (%)



FIGURE 27. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET, BY COUNTRY, 2017-2025 (%)

FIGURE 28. U.S. HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 29. CANADA HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 30. MEXICO HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 31. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET, BY COUNTRY, 2017-2025 (%)

FIGURE 32. U.K. HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 33. GERMANY HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 34. FRANCE HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 35. RUSSIA HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 36. REST OF EUROPE HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 37. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET, BY COUNTRY, 2017-2025 (%)

FIGURE 38. CHINA HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 39. JAPAN HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 40. INDIA HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 41. SOUTH KOREA HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 42. REST OF ASIA-PACIFIC HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 43. COMPARATIVE SHARE ANALYSIS OF HDI PCB MARKET, BY COUNTRY, 2017-2025 (%)

FIGURE 44. LATIN AMERICA HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 45. MIDDLE EAST HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 46. AFRICA HDI PCB MARKET, 2017-2025 (\$MILLION)

FIGURE 47. AT&S: NET SALES, 2015-2017 (\$MILLION)

FIGURE 48. AT&S: REVENUE SHARE BY SEGMENT, 2017 (%)

FIGURE 49. AT&S: REVENUE SHARE BY REGION, 2017 (%)

FIGURE 50. COMPEQ: NET SALES, 2015-2017 (\$MILLION)

FIGURE 51. COMPEQ: REVENUE SHARE BY SEGMENT, 2017 (%)

FIGURE 52. COMPEQ: REVENUE SHARE BY REGION, 2017 (%)

FIGURE 53. DAP CORPORATION: NET SALES, 2015-2017 (\$MILLION)

FIGURE 54. IBIDEN CO., LTD.: NET SALES, 2015-2017 (\$MILLION)

FIGURE 55. IBIDEN CO., LTD.: REVENUE SHARE BY SEGMENT, 2017 (%)

FIGURE 56. IBIDEN CO., LTD.: REVENUE SHARE BY REGION, 2017 (%)

FIGURE 57. MEIKO ELECTRONICS CO., LTD.: NET SALES, 2015-2017 (\$MILLION)

FIGURE 58. MEIKO ELECTRONICS CO., LTD.: REVENUE SHARE BY REGION, 2017 (%)

FIGURE 59. SEMCO: NET SALES, 2015-2017 (\$MILLION)

FIGURE 60. SEMCO: REVENUE SHARE BY SEGMENT, 2017 (%)



- FIGURE 61. SEMCO: REVENUE SHARE BY REGION, 2017 (%)
- FIGURE 62. TTM TECHNOLOGIES: NET SALES, 20152017 (\$MILLION)
- FIGURE 63. TTM TECHNOLOGIES: REVENUE SHARE BY SEGMENT, 2017 (%)
- FIGURE 64. TTM TECHNOLOGIES: REVENUE SHARE BY REGION, 2017 (%)
- FIGURE 65. TRIPOD TECHNOLOGY: NET SALES, 20152017 (\$MILLION)
- FIGURE 66. UNIMICRON: NET SALES, 20152017 (\$MILLION)
- FIGURE 67. UNIMICRON: REVENUE SHARE BY SEGMENT, 2017 (%)
- FIGURE 68. UNITECH PCB: NET SALES, 20152017 (\$MILLION)

## I would like to order

Product name: High-Density Interconnect (HDI) PCB Market by End User (Consumer Electronics, Automotive, Industrial Electronics, IT & Telecommunications, and Others) and Application (Smartphone & Tablet, Laptop & PC, Smart Wearables, and Others): Global Opportunity Analysis and Industry Forecast, 2018 - 2025

Product link: <https://marketpublishers.com/r/H801795DA08EN.html>

Price: US\$ 4,296.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

[info@marketpublishers.com](mailto:info@marketpublishers.com)

## Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/H801795DA08EN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:  
Last name:  
Email:  
Company:  
Address:  
City:  
Zip code:  
Country:  
Tel:  
Fax:  
Your message:

**\*\*All fields are required**

Customer signature \_\_\_\_\_

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below  
and fax the completed form to +44 20 7900 3970